

INTERCONNECTS

SERIES 830, 831, 832, 833 • 2mm GRID HEADERS AND SOCKETS • SINGLE AND DOUBLE ROW STRIPS

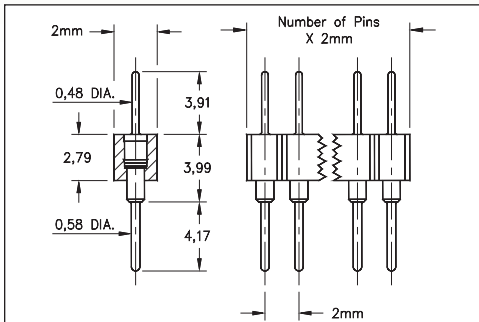


FIG. 1

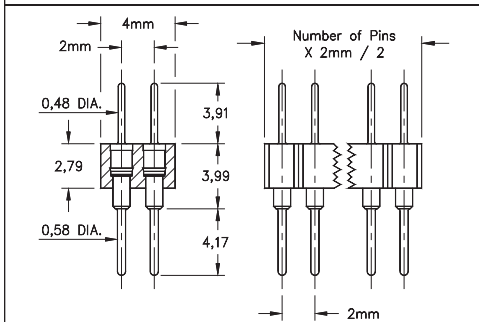


FIG. 2

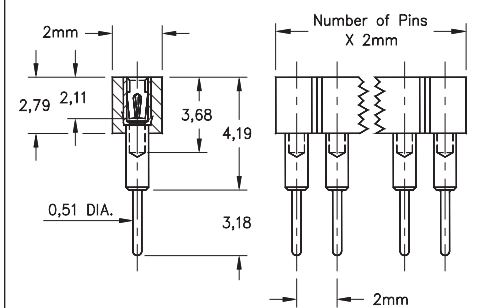


FIG. 3

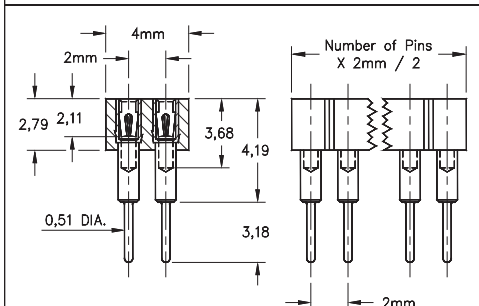
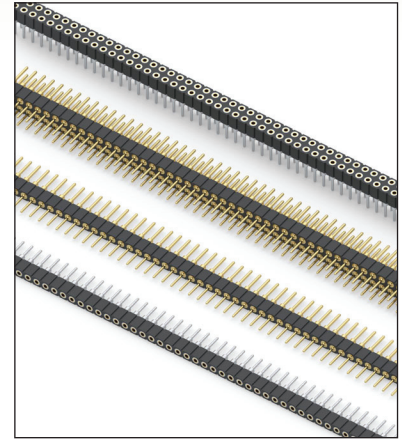


FIG. 4

- Series 830 single & double row interconnects have 2mm pin spacing and permit board stacking as low as 8,18
- Pin headers (830 & 832 series) use MM #5012 pins. See page 208 for details
- Sockets (831 & 833 series) use MM #1802 receptacles and accept pin diameters from 0,38 - 0,64. See page 169 for details
- Contact is rated at 3 amps
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION



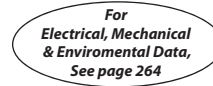
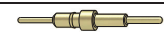




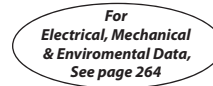





FIG. 1	Series 830...001	Single Row Pin Header		
	830-XX-0	-10-001000	Specify number of pins → 01-50	
FIG. 2	Series 832...001	Double Row Pin Header		
	832-XX-	-10-001000	Specify number of pins → 004-100	
  				
SPECIFY PLATING CODE XX=				
Pin Plating 				
	10 	90	40 	
	0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	

FIG. 3	Series 831...001	Single Row Socket				
	831-XX-0	-10-001000	Specify number of pins → 01-50			
FIG. 4	Series 833...001	Double Row Socket				
	833-XX-	-10-001000	Specify number of pins → 004-100			
  						
SPECIFY PLATING CODE XX=						
Sleeve (Pin) 						
Contact (Clip) 						
	91	93	41 	43 	47 	
	5,08µm Sn/Pb	5,08µm Sn/Pb	5,08µm Sn	5,08µm Sn	5,08µm Sn	
	0,25µm Au	0,76µm Au	0,25µm Au	0,76µm Au	Au Flash	